

## Offline LED driver with primary-sensing and high power factor up to 7 W

Datasheet – production data

### Features

- High power factor capability ( $> 0.9$ )
- 800 V, avalanche rugged internal  $11 \Omega$  power MOSFET
- Internal high-voltage startup
- Primary sensing regulation (PSR)
- $\pm 5\%$  accuracy on constant LED output current
- Quasi-resonant (QR) operation
- Optocoupler not needed
- Open or short LED string management
- Automatic self supply

### Applications

- AC-DC LED driver bulb replacement lamps up to 7 W, with high power factor
- AC-DC LED drivers up to 7 W

### Description

The HVLED807PF is a high-voltage primary switcher intended to operate directly from the rectified mains with minimum external parts and enabling high power factor ( $> 0.90$ ) to provide an efficient, compact and cost effective solution for LED driving. It combines a high-performance low-voltage PWM controller chip and an 800 V, avalanche-rugged Power MOSFET, in the same package. There is no need for an optocoupler thanks to the patented primary sensing regulation (PSR) technique. The device assures protection against LED string fault (open or short).

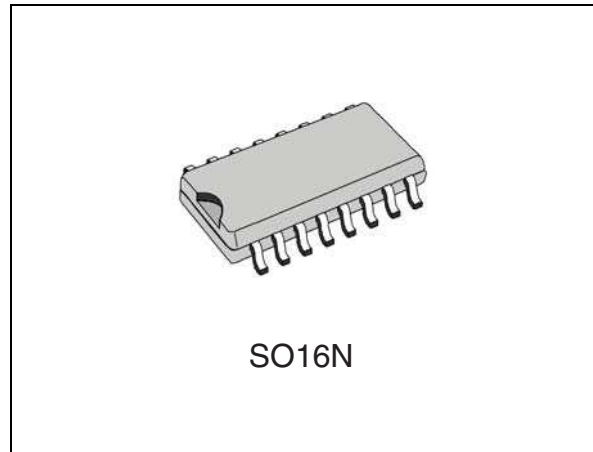


Table 1. Device summary

Order code	Package	Packaging
HVLED807PF	SO16N	Tube
HVLED807PFTR		Tape & Reel

# Contents

<b>1</b>	<b>Principle application circuit and block diagram</b> .....	<b>3</b>
1.1	Principle application circuit .....	3
1.2	Block diagram .....	5
<b>2</b>	<b>Pin description and connection diagrams</b> .....	<b>6</b>
2.1	Pin description .....	6
2.2	Thermal data .....	7
<b>3</b>	<b>Electrical specifications</b> .....	<b>8</b>
3.1	Absolute maximum ratings .....	8
3.2	Electrical characteristics .....	8
<b>4</b>	<b>Device description</b> .....	<b>13</b>
<b>5</b>	<b>Package information</b> .....	<b>14</b>
<b>6</b>	<b>Revision history</b> .....	<b>17</b>



# 1 Principle application circuit and block diagram

## 1.1 Principle application circuit

Figure 1. Principle application circuit for high power factor LED driver

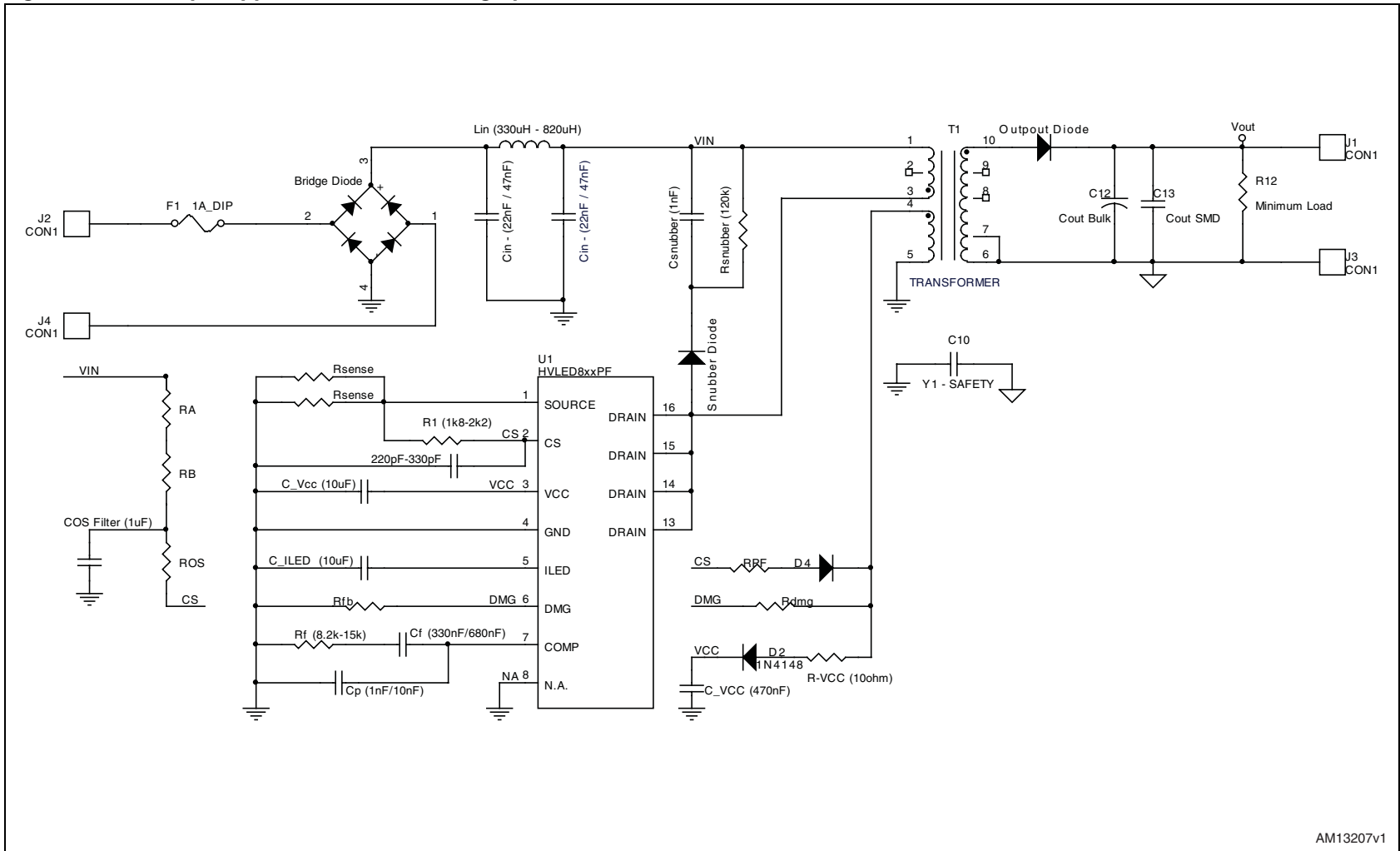
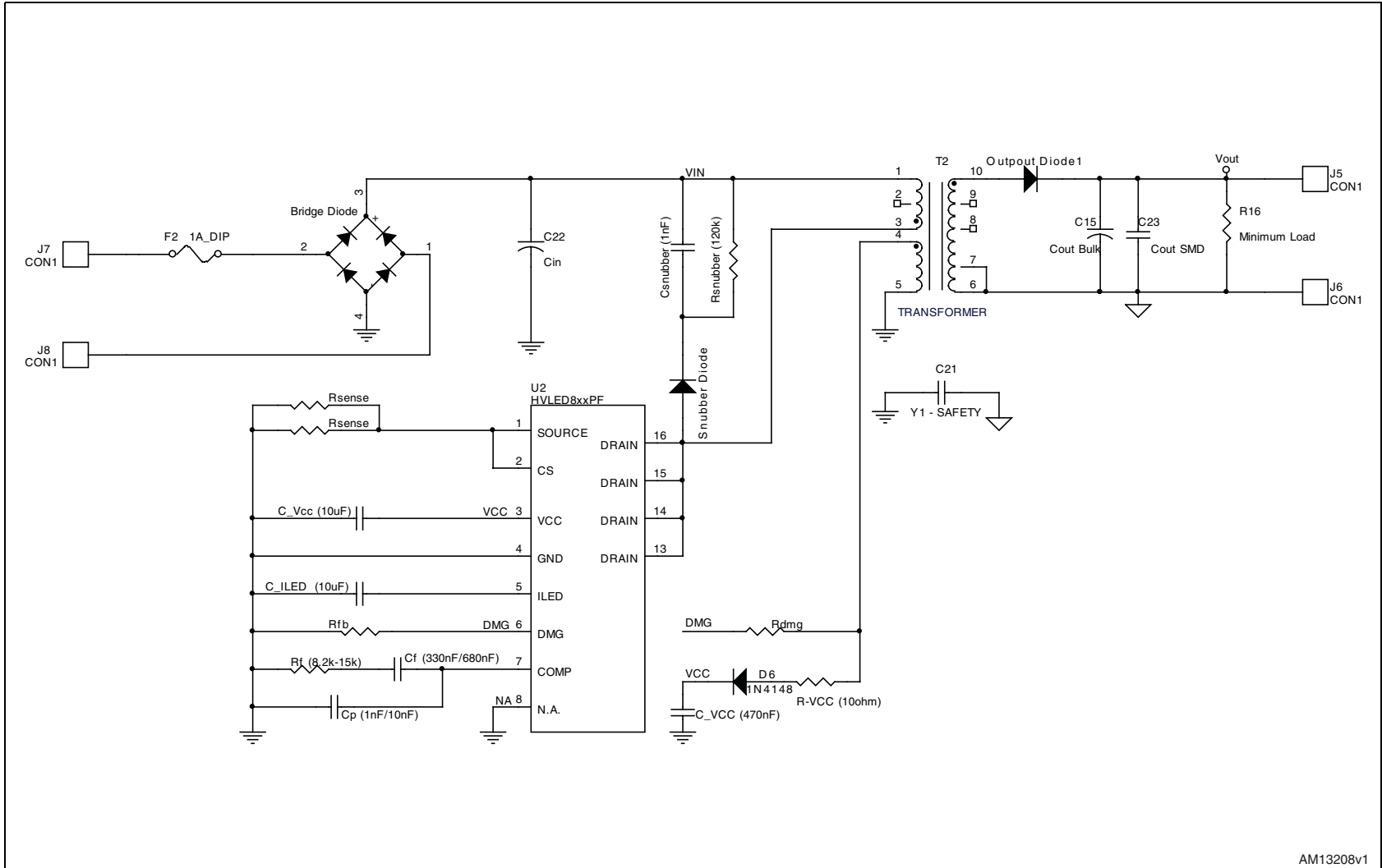




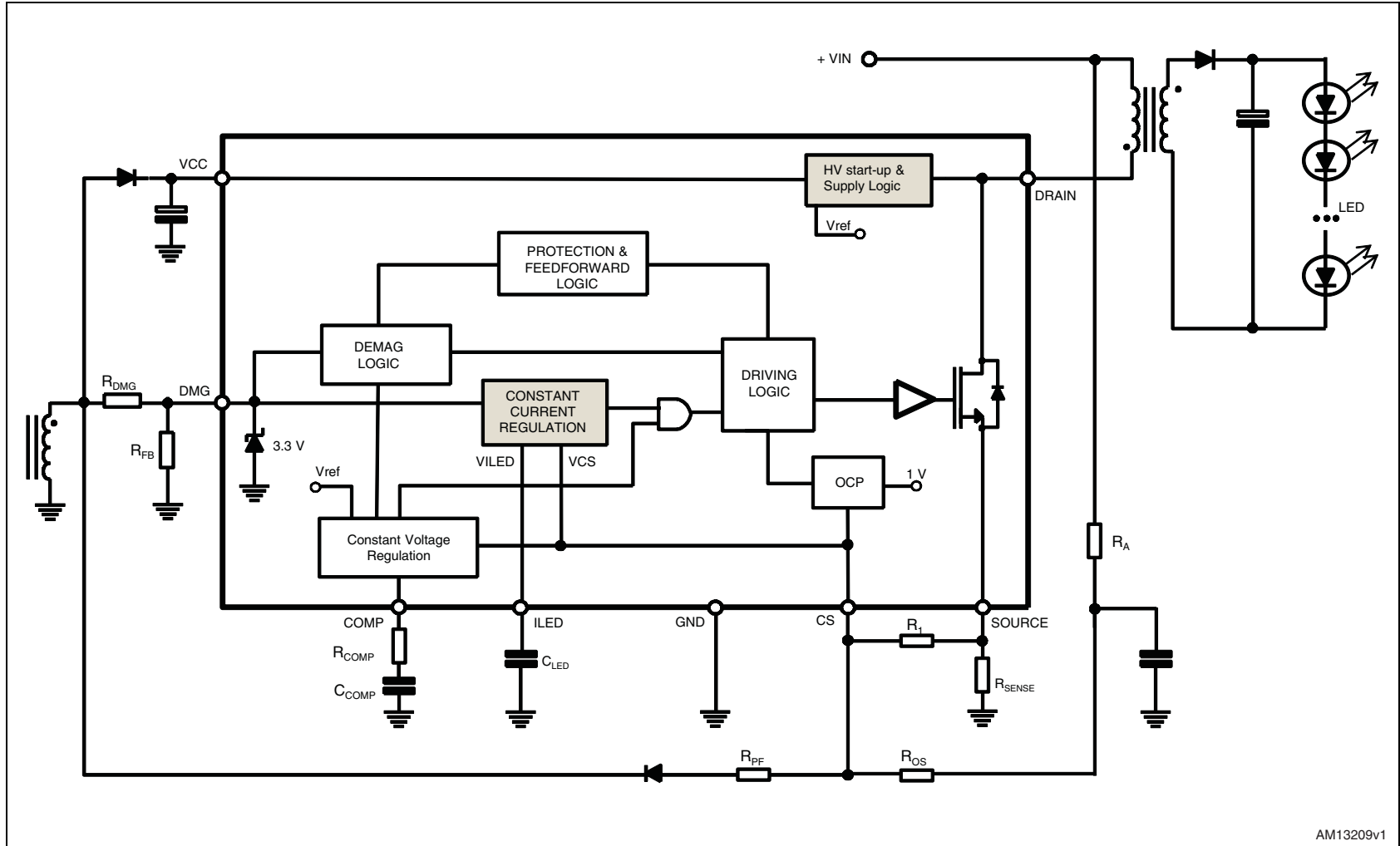
Figure 2. Principle application circuit for standard LED driver





## 1.2 Block diagram

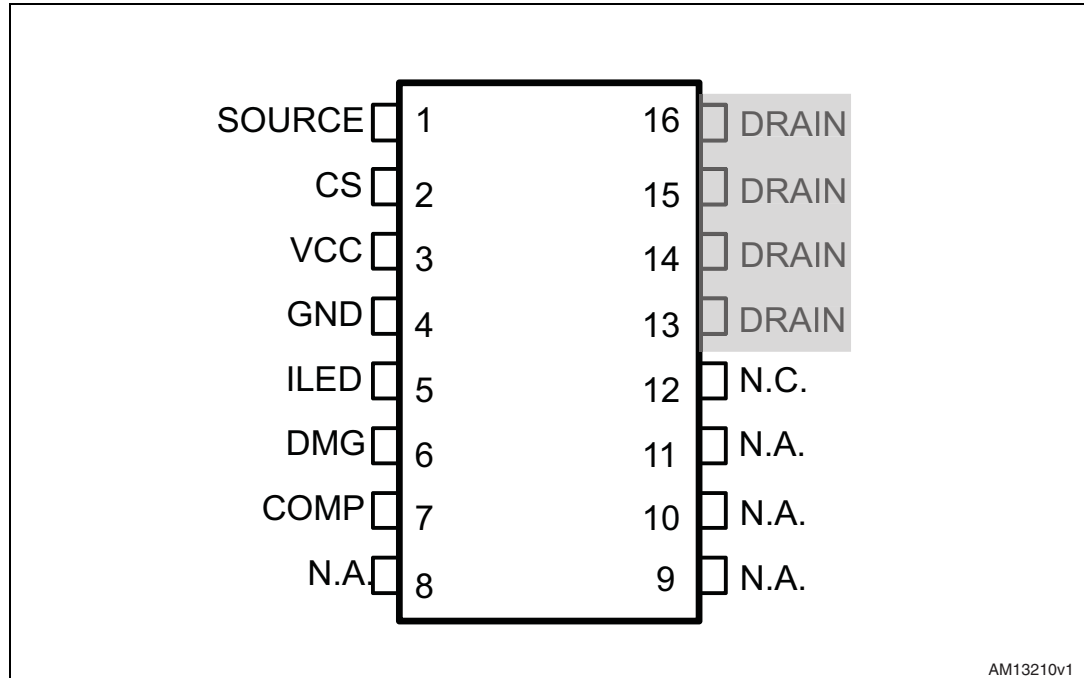
Figure 3. Block diagram



AM13209v1

## 2 Pin description and connection diagrams

Figure 4. Pin connection (top view)



### 2.1 Pin description

Table 2. Pin description

N.	Name	Function
1	SOURCE	Source connection of the internal power section.
2	CS	Current sense input. Connect this pin to the SOURCE pin (through an R1 resistor) to sense the current flowing in the MOSFET through an R <sub>SENSE</sub> resistor connected to GND. The CS pin is also connected through dedicated ROS, RPF resistors to the input and auxiliary voltage, in order to modulate the input current flowing in the MOSFET according to the input voltage and therefore achieving a high power factor. See dedicated section for more details. The resulting voltage is compared with the voltage on the ILED pin to determine MOSFET turn-off. The pin is equipped with 250 ns blanking time after the gate-drive output goes high for improved noise immunity. If a second comparison level located at 1 V is exceeded, the IC is stopped and restarted after V <sub>CC</sub> has dropped below 5 V.
3	VCC	Supply voltage of the device. A capacitor, connected between this pin and ground, is initially charged by the internal high-voltage startup generator; when the device is running, the same generator keeps it charged in case the voltage supplied by the auxiliary winding is not sufficient. This feature is disabled in case a protection is tripped. A small bypass capacitor (100 nF typ.) to GND may be useful to get a clean bias voltage for the signal part of the IC.

**Table 2. Pin description (continued)**

N.	Name	Function
4	GND	Ground. Current return for both the signal part of the IC and the gate drive. All of the ground connections of the bias components should be tied to a trace going to this pin and kept separate from any pulsed current return.
5	I <sub>LED</sub>	Constant current (CC) regulation loop reference voltage. An external capacitor $C_{LED}$ is connected between this pin and GND. An internal circuit develops a voltage on this capacitor that is used as the reference for the MOSFET's peak drain current during CC regulation. The voltage is automatically adjusted to keep the average output current constant.
6	DMG	Transformer demagnetization sensing for quasi-resonant operation and output voltage monitor. A negative-going edge triggers the MOSFET turn-on, to achieve quasi-resonant operation (zero voltage switching). The pin voltage is also sampled-and-held right at the end of transformer demagnetization to get an accurate image of the output voltage to be fed to the inverting input of the internal, transconductance-type, error amplifier, whose non-inverting input is referenced to 2.5 V. The maximum $I_{DMG}$ sunk/sourced current must not exceed $\pm 2$ mA (AMR) in all the $V_{in}$ range conditions. No capacitor is allowed between the pin and the auxiliary transformer.
7	COMP	Output of the internal transconductance error amplifier. The compensation network is placed between this pin and GND to achieve stability and good dynamic performance of the voltage control loop.
8	N.a.	Not available. These pins must be connected to GND.
9-11	N.a.	Not available. These pins must be left not connected.
12	N.c.	Not internally connected. Provision for clearance on the PCB to meet safety requirements.
13 to 16	DRAIN	Drain connection of the internal power section. The internal high-voltage startup generator sinks current from this pin as well. Pins connected to the internal metal frame to facilitate heat dissipation.

## 2.2 Thermal data

**Table 3. Thermal data**

Symbol	Parameter	Max. value	Unit
$R_{thJP}$	Thermal resistance, junction-to-pin	10	°C/W
$R_{thJA}$	Thermal resistance, junction-to-ambient	110	°C/W
$P_{TOT}$	Maximum power dissipation at $T_A = 50$ °C	0.9	W
$T_{MAX}$	Maximum junction temperature	150	°C
$T_{STG}$	Storage temperature range	-55 to 150	°C
$T_J$	Junction temperature range	-40 to 125	°C

## 3 Electrical specifications

### 3.1 Absolute maximum ratings

**Table 4. Absolute maximum ratings**

Symbol	Pin	Parameter	Value	Unit
$V_{DS}$	1, 13-16	Drain-to-source (ground) voltage	-1 to 800	V
$I_D$	1, 13-16	Drain current <sup>(1)</sup>	1	A
$E_{av}$	1, 13-16	Single-pulse avalanche energy ( $T_j = 25\text{ °C}$ , $I_D = 0.7\text{ A}$ )	50	mJ
$V_{CC}$	3	Supply voltage ( $I_{CC} < 25\text{ mA}$ )	Self limiting	V
$I_{DMG}$	6	Zero current detector current	$\pm 2$	mA
$V_{CS}$	2	Current sense analog input	-0.3 to 3.6	V
$V_{comp}$	7	Analog input	-0.3 to 3.6	V

1. Limited by maximum temperature allowed.

### 3.2 Electrical characteristics

**Table 5. Electrical characteristics<sup>(1) (2)</sup>**

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
Power section						
$V_{(BR)DSS}$	Drain-source breakdown	$I_D < 100\text{ }\mu\text{A}$ ; $T_j = 25\text{ °C}$	800			V
$I_{DSS}$	OFF-state drain current	$V_{DS} = 750\text{ V}$ ; $T_j = 125\text{ °C}$ ( <sup>3</sup> ), see <a href="#">Figure 5</a>			80	$\mu\text{A}$
$R_{DS(on)}$	Drain-source ON-state resistance	$I_D = 250\text{ mA}$ ; $T_j = 25\text{ °C}$		6	7.4	$\Omega$
		$I_D = 250\text{ mA}$ ; $T_j = 125\text{ °C}$ ( <sup>3</sup> )			14.8	
$C_{OSS}$	Effective (energy-related) output capacitance	( <sup>3</sup> ) See <a href="#">Figure 6</a>				
High-voltage startup generator						
$V_{START}$	Min. drain start voltage	$I_{charge} < 100\text{ }\mu\text{A}$	40	50	60	V
$I_{CHARGE}$	$V_{CC}$ startup charge current	$V_{DRAIN} > V_{Start}$ ; $V_{CC} < V_{CCOn}$ $T_j = 25\text{ °C}$	4	5.5	7	mA
		$V_{DRAIN} > V_{Start}$ ; $V_{CC} < V_{CCOn}$	+/- 10%			
$V_{CC\_RESTART}$	$V_{CC}$ restart voltage ( $V_{CC}$ falling)	( <sup>4</sup> )	9.5	10.5	11.5	V
		After protection tripping		5		



Table 5. Electrical characteristics<sup>(1) (2)</sup> (continued)

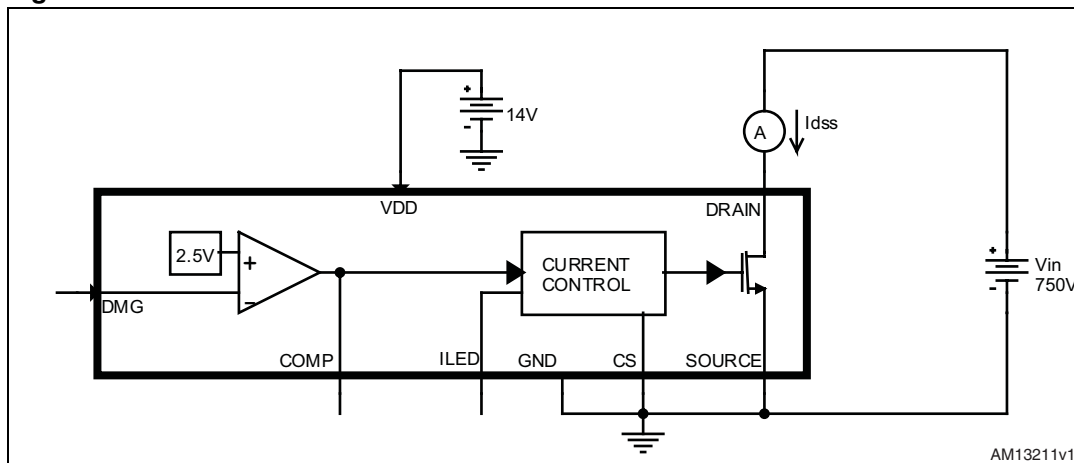
Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
Supply voltage						
V <sub>CC</sub>	Operating range	After turn-on	11.5		23	
V <sub>CC_ON</sub>	Turn-on threshold	(4)	12	13	14	V
V <sub>CC_OFF</sub>	Turn-off threshold	(4)	9	10	11	V
V <sub>Z</sub>	Internal Zener voltage	I <sub>CC</sub> = 20 mA	23	25	27	V
Supply current						
I <sub>CC_START-UP</sub>	Startup current	See <a href="#">Figure 7</a>		200	300	μA
I <sub>q</sub>	Quiescent current	See <a href="#">Figure 8</a>		1	1.4	mA
I <sub>CC</sub>	Operating supply current at 50 kHz	See <a href="#">Figure 9</a>		1.4	1.7	mA
I <sub>q(fault)</sub>	Fault quiescent current	See <a href="#">Figure 10</a>		250	350	μA
Startup timer						
T <sub>START</sub>	Start timer period		105	140	175	μs
T <sub>RESTART</sub>	Restart timer period during burst mode		420	500	700	μs
Demagnetization detector						
I <sub>Dmgb</sub>	Input bias current	V <sub>DMG</sub> = 0.1 to 3 V		0.1	1	μA
V <sub>DMGH</sub>	Upper clamp voltage	I <sub>DMG</sub> = 1 mA	3.0	3.3	3.6	V
V <sub>DMGL</sub>	Lower clamp voltage	I <sub>DMG</sub> = - 1 mA	-90	-60	-30	mV
V <sub>DMGA</sub>	Arming voltage	Positive-going edge	100	110	120	mV
V <sub>DMGT</sub>	Triggering voltage	Negative-going edge	50	60	70	mV
T <sub>BLANK</sub>	Trigger blanking time after MOSFET turn-off	V <sub>COMP</sub> ≥ 1.3 V		6		μs
		V <sub>COMP</sub> = 0.9 V		30		
Line feedforward						
R <sub>FF</sub>	Equivalent feedforward resistor	I <sub>DMG</sub> = 1 mA		45		Ω
Transconductance error amplifier						
V <sub>REF</sub>	Voltage reference	T <sub>j</sub> = 25 °C	2.45	2.51	2.57	V
		(3) T <sub>j</sub> = -25 to 125 °C and V <sub>CC</sub> = 12 V to 23 V	2.4		2.6	
gm	Transconductance	ΔI <sub>COMP</sub> = ± 10 μA V <sub>COMP</sub> = 1.65 V	1.3	2.2	3.2	ms
G <sub>v</sub>	Voltage gain	(5) Open loop		73		dB
GB	Gain-bandwidth product	(5)		500		KHz

**Table 5. Electrical characteristics<sup>(1) (2)</sup> (continued)**

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
I <sub>COMP</sub>	Source current	V <sub>DMG</sub> = 2.3 V, V <sub>COMP</sub> = 1.65 V	70	100		μA
	Sink current	V <sub>DMG</sub> = 2.7 V, V <sub>COMP</sub> = 1.65 V	400	750		μA
V <sub>COMPH</sub>	Upper COMP voltage	V <sub>DMG</sub> = 2.3 V		2.7		V
V <sub>COMPL</sub>	Lower COMP voltage	V <sub>DMG</sub> = 2.7 V		0.7		V
V <sub>COMPBM</sub>	Burst-mode threshold			1		V
Hys	Burst-mode hysteresis			65		mV
Current reference						
V <sub>ILEDx</sub>	Maximum value	V <sub>COMP</sub> = V <sub>COMPL</sub>	1.5	1.6	1.7	V
V <sub>CLED</sub>	Current reference voltage		0.192	0.2	0.208	V
Current sense						
t <sub>LEB</sub>	Leading-edge blanking	(5)		330		ns
T <sub>D</sub>	Delay-to-output (H-L)			90	200	ns
V <sub>CSx</sub>	Max. clamp value	(4) dVcs/dt = 200 mV/μs	0.7	0.75	0.8	V
V <sub>CSdis</sub>	Hiccup-mode OCP level	(4)	0.92	1	1.08	V

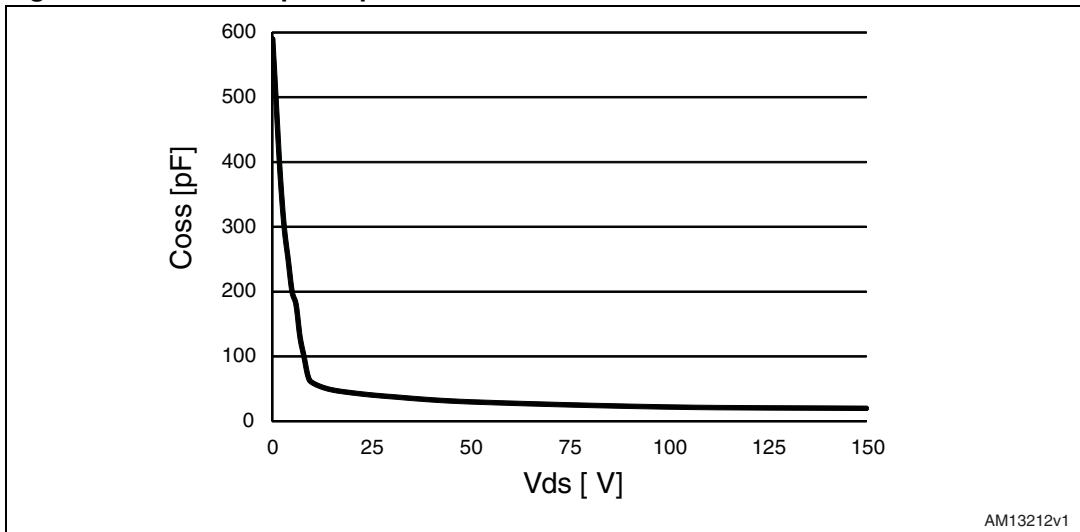
1. V<sub>cc</sub>=14 V (unless otherwise specified).
2. Limits are production tested at T<sub>j</sub>=T<sub>a</sub>=25 °C, and are guaranteed by statistical characterization in the range T<sub>j</sub> 25-125 °C.
3. Not production tested, guaranteed statistical characterization only.
4. Parameters tracking each other (in the same section).
5. Guaranteed by design.

**Figure 5. OFF-state drain and source current test circuit**



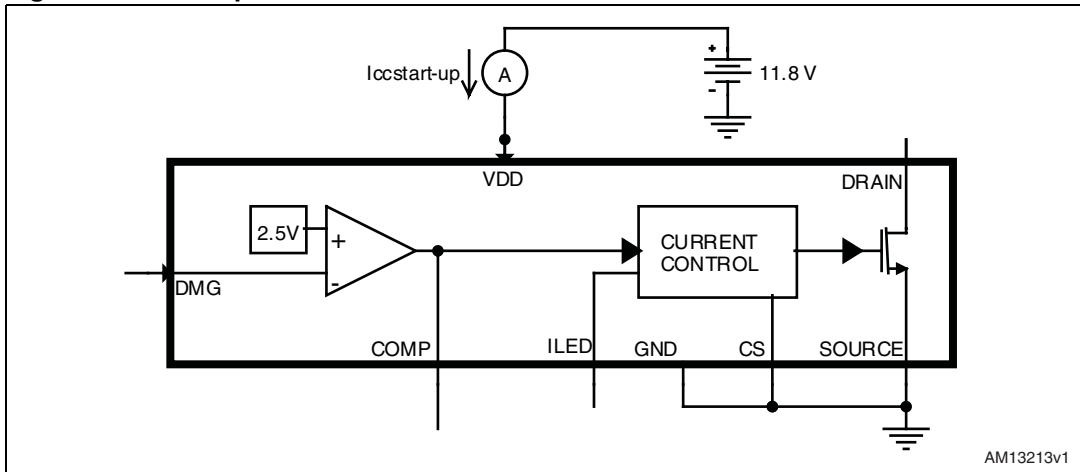
**Note:** The measured IDSS is the sum between the current across the startup resistor and the effective MOSFET's OFF-state drain current.

Figure 6. COSS output capacitance variation



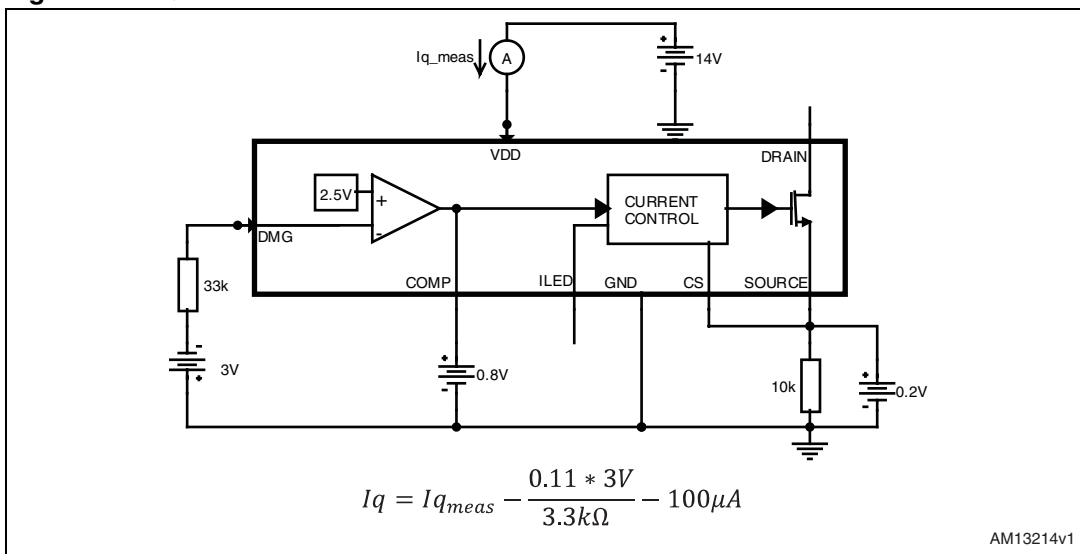
AM13212v1

Figure 7. Startup current test circuit



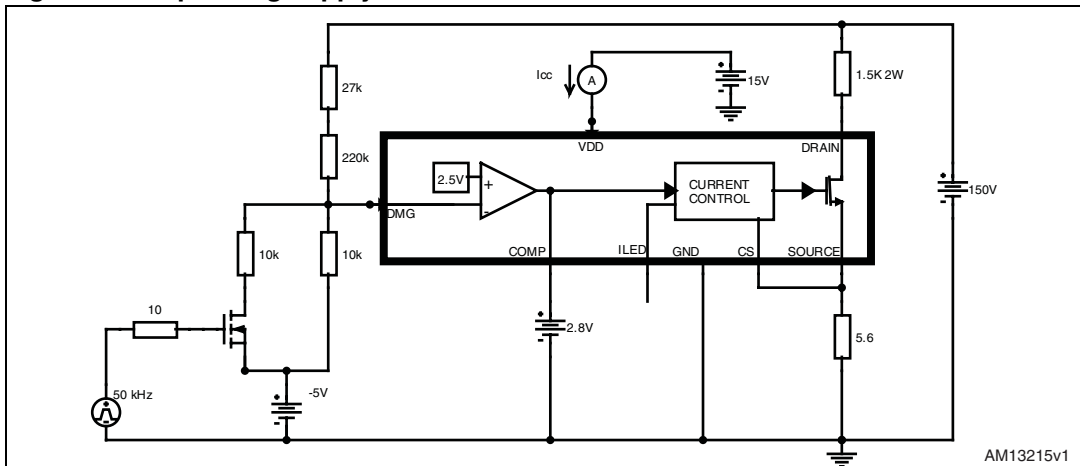
AM13213v1

Figure 8. Quiescent current test circuit



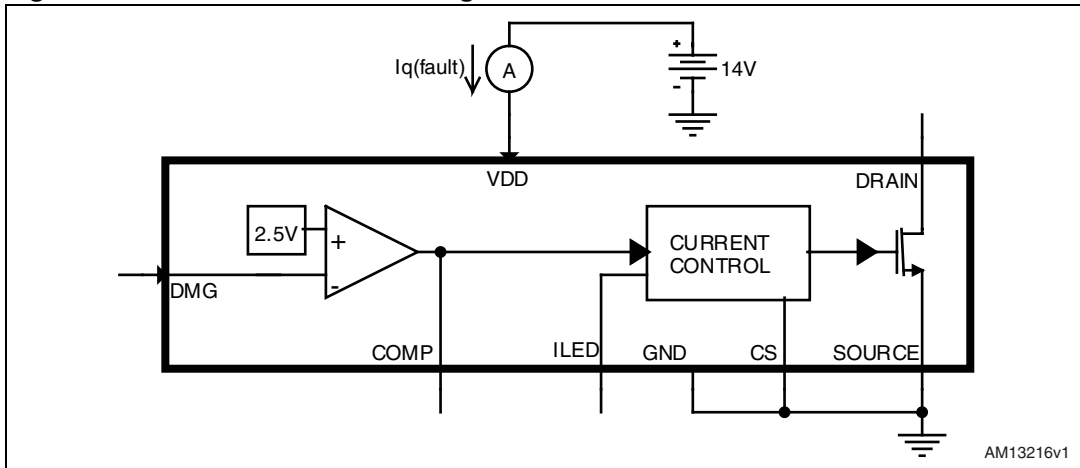
AM13214v1

**Figure 9. Operating supply current test circuit**



*Note: The circuit across the DMG pin is used for switch-on synchronization.*

**Figure 10. Quiescent current during fault test circuit**



## 4 Device description

The HVLED807PF is a high-voltage primary switcher intended to operate directly from the rectified mains with minimum external parts to provide high power factor ( $> 0.90$ ) and an efficient, compact and cost effective solution for LED driving. It combines a high-performance low-voltage PWM controller chip and an 800 V, avalanche-rugged Power MOSFET, in the same package.

The PWM is a current-mode controller IC specifically designed for ZVS (zero voltage switching) flyback LED drivers, with constant output current (CC) regulation using primary sensing feedback (PSR). This eliminates the need for the optocoupler, the secondary voltage reference, as well as the current sense on the secondary side, while still maintaining a good LED current accuracy. Moreover, it guarantees a safe operation when short-circuit of one or more LEDs occurs.

The device can also provide a constant output voltage regulation (CV): it allows the application to be able to work safely when the LED string opens due to a failure.

In addition, the device offers the shorted secondary rectifier (i.e. LED string shorted due to a failure) or transformer saturation detection.

Quasi-resonant operation is achieved by means of a transformer demagnetization sensing input that triggers MOSFET turn-on. This input serves also as both output voltage monitor, to perform CV regulation, and input voltage monitor, to achieve mains-independent CC regulation (line voltage feedforward).

The maximum switching frequency is top-limited below 166 kHz, so that at medium-light load a special function automatically lowers the operating frequency still maintaining the operation as close to ZVS as possible. At very light load, the device enters a controlled burst-mode operation that, along with the built-in high-voltage startup circuit and the low operating current of the device, helps minimize the residual input consumption.

Although an auxiliary winding is required in the transformer to correctly perform CV/CC regulation, the chip is able to power itself directly from the rectified mains. This is useful especially during CC regulation, where the flyback voltage generated by the winding drops.

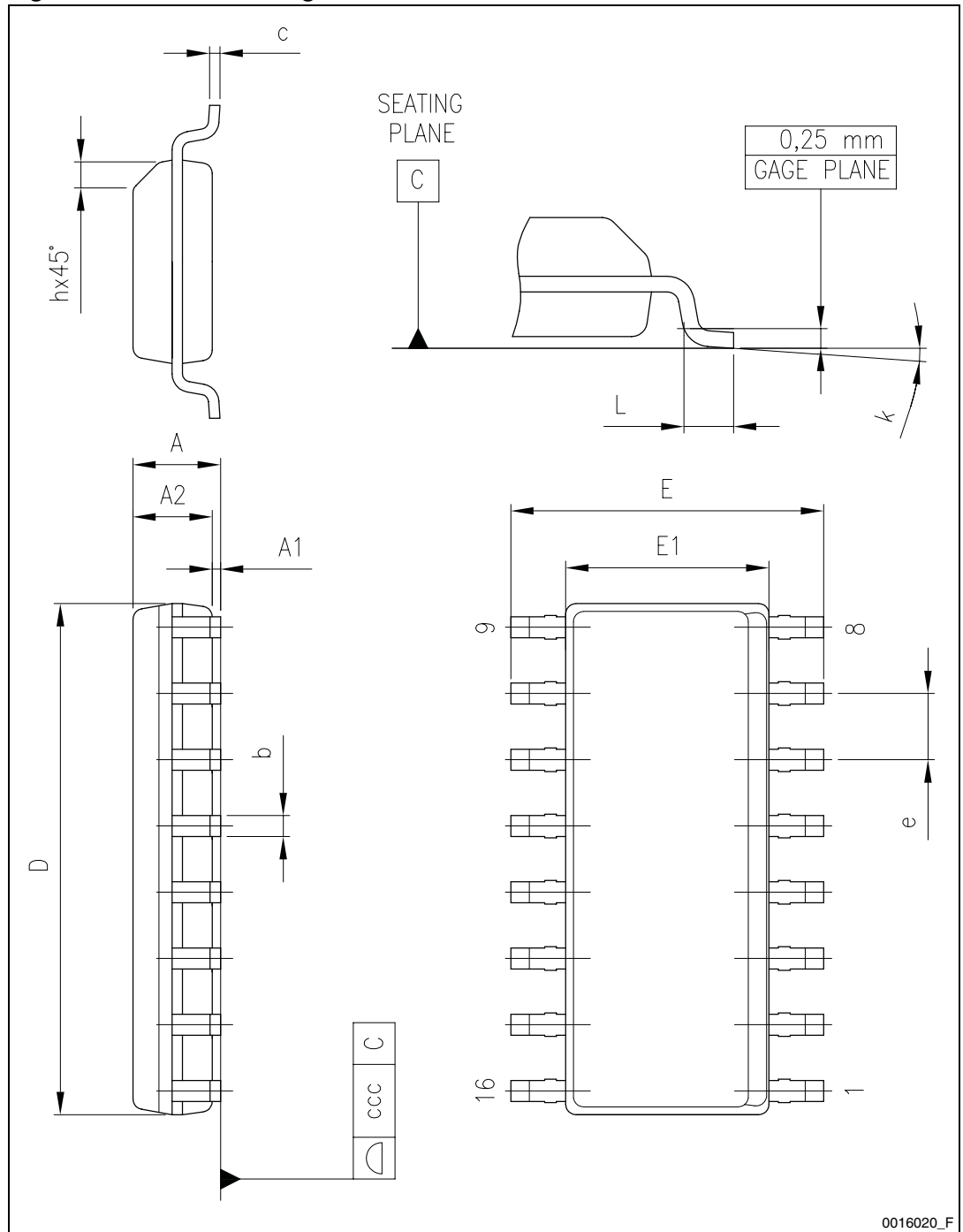
## 5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

**Figure 11. SO16N mechanical data**

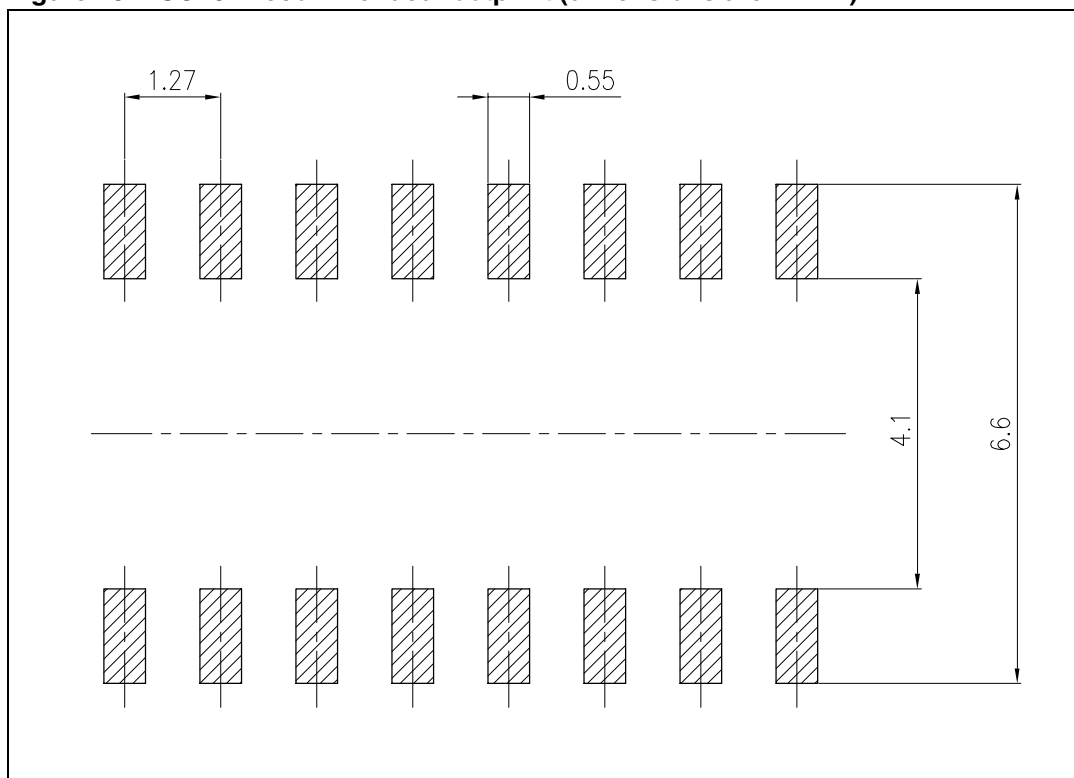
Dim.	mm		
	Min.	Typ.	Max.
A			1.75
A1	0.10		0.25
A2	1.25		
b	0.31		0.51
c	0.17		0.25
D	9.80	9.90	10.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e		1.27	
h	0.25		0.50
L	0.40		1.27
k	0		8°
ccc			0.10

Figure 12. SO16N drawing



0016020\_F

Figure 13. SO16N recommended footprint (dimensions are in mm)





## 6 Revision history

**Table 6. Document revision history**

Date	Revision	Changes
26-Jul-2012	1	Initial release.
29-Aug-2012	2	Added <a href="#">Table 2: Pin description on page 6</a> .

**Please Read Carefully:**

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

**UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.**

**UNLESS EXPRESSLY APPROVED IN WRITING BY TWO AUTHORIZED ST REPRESENTATIVES, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.**

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2012 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

[www.st.com](http://www.st.com)